

Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- High Reverse Breakdown Voltage Rating
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3 & 4)**
- **Qualified to AEC-Q101 Standards for High Reliability**

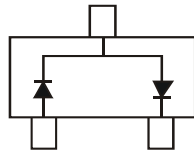
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)

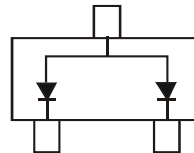
SOT23



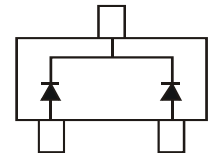
Top View



MMBD3004S Marking: KAE



MMBD3004A Marking: KAD



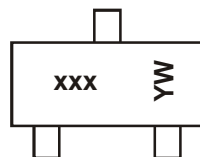
MMBD3004C Marking: KAC

Ordering Information (Note 5)

Part Number	Qualification	Case	Packaging
MMBD3004S-7-F	Commercial	SOT23	3000/Tape & Reel
MMBD3004SQ-7-F	Automotive	SOT23	3000/Tape & Reel
MMBD3004S-13-F	Commercial	SOT23	10,000/Tape & Reel
MMBD3004A-7-F	Commercial	SOT23	3000/Tape & Reel
MMBD3004C-7-F	Commercial	SOT23	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Product manufactured with Date Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.
 5. For Packaging Details, go to our website at <http://www.diodes.com>.

Marking Information



xxx = Product Type Marking Code
 KAE = MMBD3004S
 KAD = MMBD3004A
 KAC = MMBD3004C
 YM = Date Code Marking
 Y = Year (ex: Z = 2012)
 M = Month (ex: 9 = September)

Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	T	U	V	W	X	Y	Z	A	B	C	D	E

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	350	V
Working Peak Reverse Voltage	V_{RWM}	300	V
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	212	V
Forward Continuous Current (Note 6)	I_F	225	mA
Peak Repetitive Forward Current (Note 6)	I_{FRM}	625	mA
Non-Repetitive Peak Forward Surge Current		@ $t = 1.0\mu\text{s}$	4.0
		@ $t = 1.0\text{s}$	1.0

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_D	350	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	357	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	350	—	—	V	$I_R = 150\mu\text{A}$
Forward Voltage	V_F	—	0.78	0.87	V	$I_F = 20\text{mA}$
			0.93	1.0		$I_F = 100\text{mA}$
			1.03	1.25		$I_F = 200\text{mA}$
Reverse Current (Note 7)	I_R	—	30	100	nA	$V_R = 240\text{V}$
			35	100	μA	$V_R = 240\text{V}, T_J = 150^\circ\text{C}$
Total Capacitance	C_T	—	1.0	5.0	pF	$V_R = 0\text{V}, f = 1.0\text{MHz}$
Reverse Recovery Time	t_{rr}	—	—	50	ns	$I_F = I_R = 30\text{mA}$, $I_{rr} = 3.0\text{mA}, R_L = 100\Omega$

Notes: 6. Part mounted on FR-4 substrate with pad dimensions 1 inch X 1 inch, 2oz, copper, single-sided, PC board.
7. Short duration pulse test used to minimize self-heating effect.

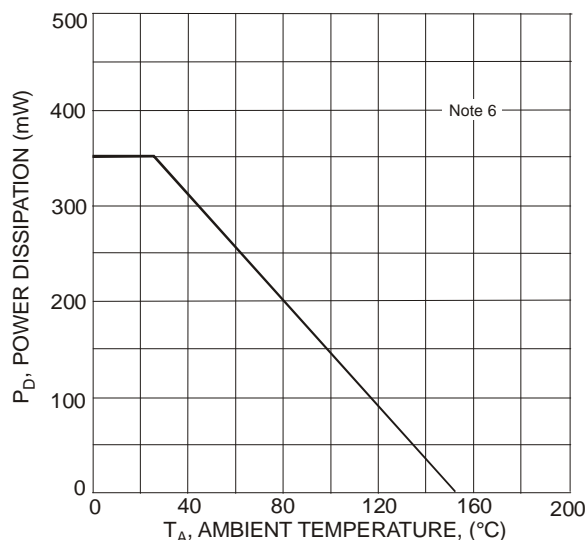


Fig. 1 Power Derating Curve, Total Package

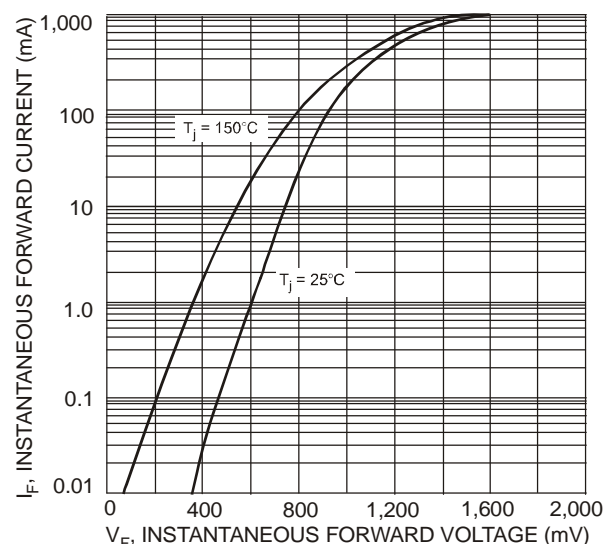


Fig. 2 Typical Forward Characteristics, Per Element

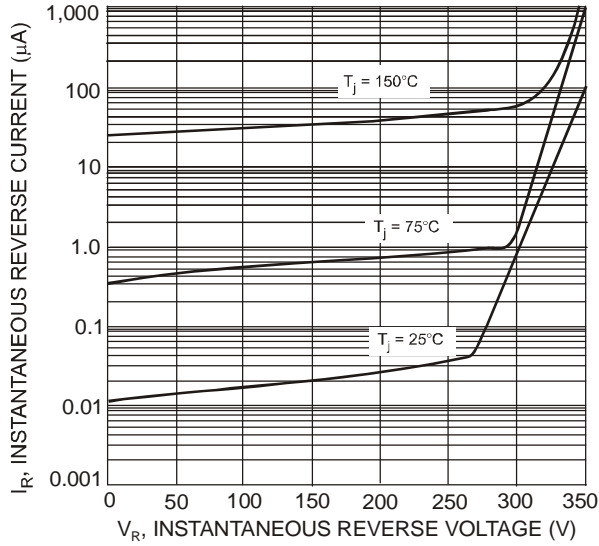


Fig. 3 Typical Reverse Characteristics, Per Element

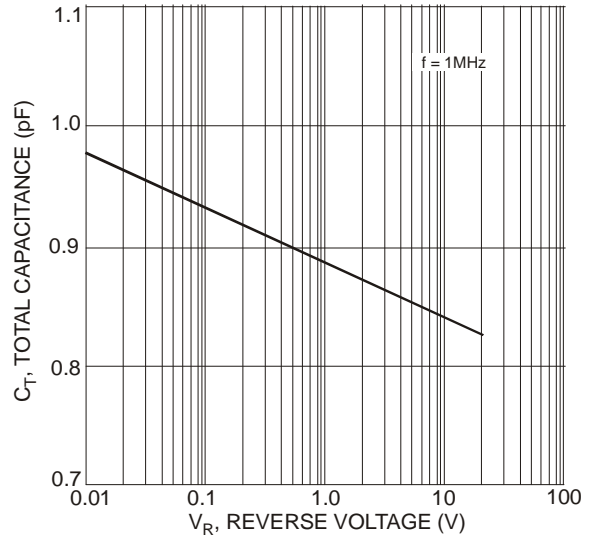
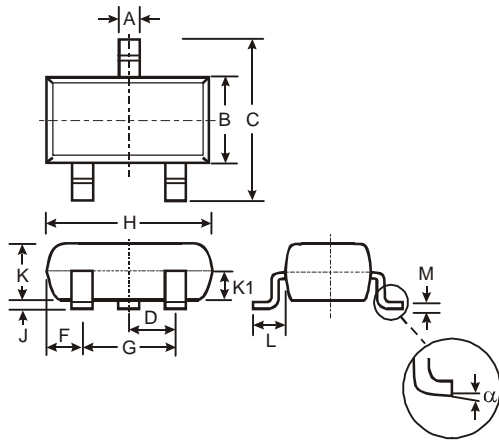


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

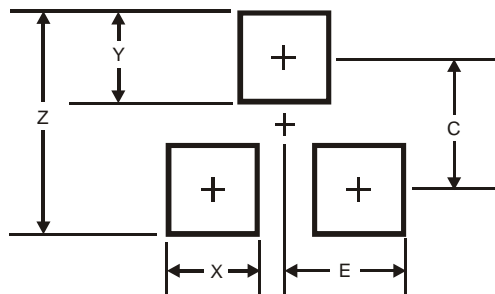
Package Outline Dimensions



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-

All Dimensions in mm

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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